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Complete housing for printed-circuit boards. Includes housing half shells, side panels with openings for all relevant connections, adhesive pads for affixing the Raspberry Pi model B2 and B3 computers, screws for housing and PCB attachment; black housing with turquoise blue corner inlays

### Your advantages

- · High degree of application flexibility, thanks to the modular housing design
- · Flexible PCB attachment, adapts to virtually all form factors
- · Practical customization options
- · Reduced logistics outlay, thanks to components which are compatible with one another
- · Delivery as a complete housing with ready-machined side panels

### Commercial data

Item number	1019723
Packing unit	1 pc
Minimum order quantity	1 pc
Sales key	AC03
Product key	ACFCAA
GTIN	4055626507446
Weight per piece (including packing)	311 g
Weight per piece (excluding packing)	311 g
Customs tariff number	84879090
Country of origin	DE

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## Technical data

#### Notes

General	The housing can be opened a maximum of 10 times.
General	Attach the adhesive pads: Make sure that the surface of the housing is clean, dry, and free of grease. Temperature range: +18°C +30°C / Closing pressure force: 60 N / Closing pressure time: 3 s

## P

Product type	Complete housing
Housing series	UCS
Product family	UCS 125-87
Туре	Flat design (GD), RPI
Housing type	Universal housings
Ventilation openings present	no

#### Dimensions

Dimensional drawing	o o h d
Width	125 mm
Height	87 mm
Depth	47 mm
Dimensions	100 mm x 62 mm (Maximum circuit board dimensions)

#### Alternative assembly

	Height	125 mm	
I	PCB design		
	PCB thickness	0.8 mm 3 mm	

#### Material specifications

Color (Housing)	black (RAL 9005)
Flammability rating according to UL 94	V0
CTI according to IEC 60112	225
Insulating material	PC
Surface characteristics	untreated
Housing material	PC

### Environmental and real-life conditions

Power dissipation single housing for 20 °C

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Ambient temperature	20 °C
Reduction factor	1
Mounting position	vertical
Power dissipation	9.7 W
Power dissipation single housing for 30 °C	
Ambient temperature	30 °C
Reduction factor	0.85
Mounting position	vertical
Power dissipation	8.3 W
Power dissipation single housing for 40 °C	
Ambient temperature	40 °C
Reduction factor	0.68
Mounting position	vertical
Power dissipation	6.5 W
Power dissipation single housing for 50 °C	
Ambient temperature	50 °C
Reduction factor	0.55
Mounting position	vertical
Power dissipation	5.4 W
Power dissipation single housing for 60 °C	
Ambient temperature	60 °C
Reduction factor	0.4
Mounting position	vertical
Power dissipation	3.9 W
Vibration test	
Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.15 mm (10 Hz 58.1 Hz)
Acceleration	2g (58.1 Hz 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis
Glow-wire test	
Specification	IEC 60695-2-11:2014-02
Temperature	850 °C
Time of exposure	30 s
Thermal stability / ball thrust test	
Specification	IEC 60695-10-2:2014-02
Temperature	125 °C
Test duration	1 h



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lechanical strength / tumbling barrel	
Specification	IEC 60068-2-31:2008-05
Height of fall	50 cm
Frequency	50
Shocks	
Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	15g
Shock duration	11 ms
Number of shocks per direction	3
Test directions	X-, Y- and Z-axis (pos. and neg.)
est for substances that would hinder coating with paint or v	zarnish
Specification	VW PV 3.10.7:2005-02
Result	Test passed
Degree of protection (IP code)	
Specification	IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08
Result, degree of protection, IP code	IP20
mbient conditions	
Max. IP code to attain	IP20
Ambient temperature (operation)	-40 °C 105 °C (depending on power dissipation)
Ambient temperature (storage/transport)	-40 °C 55 °C
Ambient temperature (assembly)	-5 °C 100 °C
Relative humidity (storage/transport)	80 %
B data	
Number of PCB holders	1
Type of PCB mount	Bolt mounting
Total PCB surface	6000 mm <sup>2</sup>
Thickness of the PCB	0.8 mm 3 mm
Supported form factors	Raspberry Pi
Note on PCB holders	This product is prepared for a printed-circuit board. Additional printed-circuit boards can be mounted using adhesive pads (accessories).
unting	
Mounting type	Screw mounting
Mounting position	any
Tightening torque / speed	Screw connection between housing halves: 1.2 Nm-1.4 Nm / 50 rpm-1000 rpm
	Mounting the PCB: 0.4 Nm-0.5 Nm / 500 rpm-1000 rpm

### Packaging specifications



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Type of packaging

Box packaging

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### Classifications

### ECLASS

	ECLASS-11.0	27182702
	ECLASS-13.0	27190603
ET	IM	
	ETIM 9.0	EC001031
UNSPSC		
	UNSPSC 21.0	31261500

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